

## PATENT ASSIGNMENT

Electronic Version v1.1  
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SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Davide Di Censo</td> <td>04/30/2012</td> </tr> <tr> <td>Stefan J. Marti</td> <td>04/27/2012</td> </tr> <tr> <td>Seung Wook Kim</td> <td>04/30/2012</td> </tr> </tbody> </table>		Name	Execution Date	Davide Di Censo	04/30/2012	Stefan J. Marti	04/27/2012	Seung Wook Kim	04/30/2012
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Davide Di Censo	04/30/2012								
Stefan J. Marti	04/27/2012								
Seung Wook Kim	04/30/2012								
RECEIVING PARTY DATA									
Name:	Hewlett-Packard Development Company, L.P.								
Street Address:	11445 Compaq Center Drive West								
City:	Houston								
State/Country:	TEXAS								
Postal Code:	77070								
PROPERTY NUMBERS Total: 1									
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13459825</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13459825				
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CORRESPONDENCE DATA									
Fax Number:	(970)778-4063								
Phone:	(541)715-8443								
Email:	pto.assignments@hp.com								
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>									
Correspondent Name:	Hewlett-Packard Company								
Address Line 1:	3404 E. Harmony Road MS 35								
Address Line 2:	Intellectual Property Administration								
Address Line 4:	Fort Collins, COLORADO 80528								
NAME OF SUBMITTER:	Deborah L. Higham								
<p>Total Attachments: 6</p> <p>source=82900760_Assignment#page1.tif</p> <p>source=82900760_Assignment#page2.tif</p> <p>source=82900760_Assignment#page3.tif</p> <p>source=82900760_Assignment#page4.tif</p> <p>source=82900760_Assignment#page5.tif</p> <p>source=82900760_Assignment#page6.tif</p>									

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HEWLETT-PACKARD COMPANY  
Intellectual Property Administrator  
3404 E. Harmony Road  
Mail Stop 35  
Fort Collins, Colorado 80528

PATENT APPLICATION

RECORD ID: 82900760

**ASSIGNMENT OF PATENT APPLICATION**

I/We, the undersigned (each) have agreed and hereby agree to assign to HEWLETT-PACKARD DEVELOPMENT COMPANY, L.P., a Texas Limited Partnership having its principal place of business in Houston, Texas, (hereinafter HPDC), in furtherance of my/our obligations to the Hewlett-Packard Company and its subsidiaries and affiliates, and do hereby assign and transfer to HPDC, its successors and assigns, the entire right, title and interest, including the right of priority, in, to and under an application for Letters Patent of the United States entitled:

**GENERATION OF A COMBINED IMAGE OF A PRESENTATION SURFACE**

Filing Date: April 30, 2012 Application No.: 13/459825


and the invention(s) and improvement(s) set forth therein, and any and all continuations, continuations-in-part (C-I-P's), divisionals, and renewals of and substitutes for said application for said Letters Patent, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or hereafter; and any reissues, or reexaminations, or extensions of said Letters Patent.

I/we additionally authorize HPDC to file applications in my/our name for Letters Patent in any country, to be held and enjoyed by HPDC, its successors, assigns, nominees or legal representatives, to the full end of the term or terms for which said Letters Patent respectively may be granted, reissued or extended, as fully and entirely as the same would have been held and enjoyed by me/us had this assignment, and transfer not been made;

AND I/we hereby covenant that I/we have full right to convey the entire interest herein assigned, and that I/we have not executed and will not execute any agreement in conflict herewith, and I/we further covenant and agree that I/we will, each time a request is made, and without undue delay, execute and deliver all such papers as may be necessary or desirable to perfect the title to said invention(s) or improvement(s), said application and said Letters Patent, to HPDC, its successors, assigns, nominees or legal representatives, and I/we agree to communicate to HPDC, or to its nominee, all known facts respecting said invention(s) or improvement(s), said application and said Letters Patent, to testify in any legal proceedings, to sign all lawful papers, to execute all disclaimers and divisionals, continuations, C-I-P's, reissue and foreign applications, to make all rightful oaths and declarations, and generally to do everything possible to aid HPDC, its successors, assigns, nominees and legal representatives to obtain and enforce, for its or their own benefit, proper patent protection for said invention(s) or improvement(s) in any and all countries provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by HPDC;

AND I/we hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any country or countries foreign to the United States whose duty it is to issue patents on applications as aforesaid, to issue to HPDC, as assignee of the entire right, title and interest, any and all Letters Patent for said invention(s) or improvement(s), including any and all Letters Patent of the United States which may be issued and granted on or as a result of the application aforesaid, in accordance with the terms of this assignment.

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Inventor's Signature

Davide Di Censo  
Inventor's Typed Name

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